PRELIMINARY SPEC

KPT-3216LCGCK

GREEN

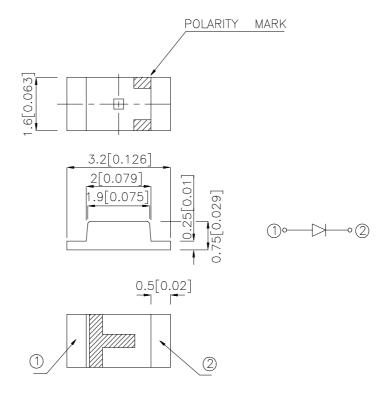
Features

- •3.2mmx1.6mm SMT LED, 0.75mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.
- •LOW CURRENT IF=2mA OPERATING.
- •Rohs Compliant.

Description

The Green source color devices are made with InGaAlP on GaAs substrate Light Emitting Diode.

Package Dimensions



Notes

- All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.0079")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) @ 2mA		Viewing Angle
			Min.	Тур.	201/2
KPT-3216LCGCK	GREEN (InGaAIP)	WATER CLEAR	0.7	3	120°

Note:

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	IF=20mA
λD	Dominant Wavelength	Green	570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	IF=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF	Forward Voltage	Green	2.1	2.5	V	IF=20mA
lR	Reverse Current	Green		10	uA	VR = 5V

Absolute Maximum Ratings at Ta=25°C

Parameter	Green	Units		
Power dissipation	105	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating/Storage Temperature	-40°C To +85°C	-40°C To +85°C		

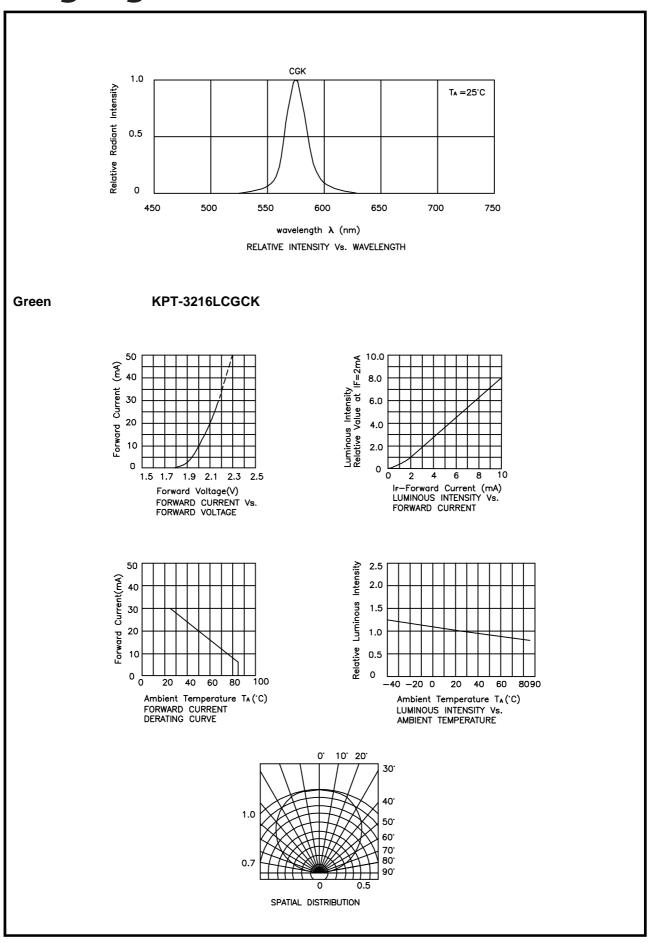
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

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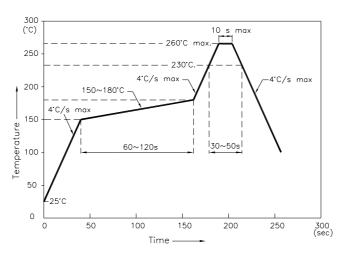


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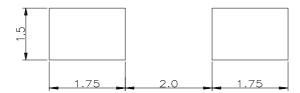
KPT-3216LCGCK

Reflow Soldering Profile For Lead-free SMT Process.

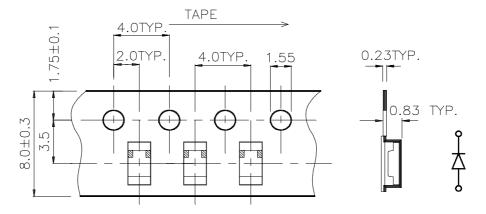


- NOTES: 1. We recommend the reflow temperature 245°C(\pm / \pm 5°C). The temperature should be limited to 260° maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm)



Tape Specifications (Units: mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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